

STPS30SM60

Power Schottky rectifier

Features

- High current capability
- Avalanche rated
- Low forward voltage drop
- High frequency operation

Description

The STPS30SM60D is a single diode Schottky rectifier, suited for high frequency switch mode power supply.

Packaged in TO-220AC, this device is intended to be used in notebook, game station and desktop adapters, providing in these aplications a good efficiency at both low and high load.

Table 1. Device summary

Symbol	Value
I _{F(AV)}	30 A
V _{RRM}	60 V
V _F (typ)	0.410 V
T _j (max)	150 °C

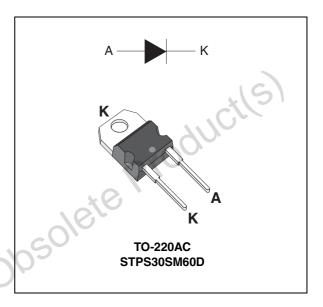
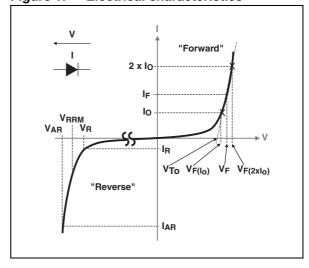


Figure 1. Electrical characteristics^(a)



V_{ARM} and I_{ARM} must respect the reverse safe operating area defined in *Figure 11*. V_{AR} and I_{AR} are pulse measurements (t_p < 1 μs). V_R, I_R, V_{RRM} and V_F, are static characteristics

Characteristics STPS30SM60

Characteristics

Absolute ratings (limiting values, at T_{amb} = 25 °C unless otherwise Table 2. specified)

Symbol		Parameter	Value	Unit	
V_{RRM}	Repetitive peak reverse volt	age		60	V
I _{F(RMS)}	Forward rms current			60	Α
I _{F(AV)}	Average forward current, $\delta = 0.5$ $T_c = 125 ^{\circ}C$				Α
I _{FSM}	Surge non repetitive forward	d current	400	Α	
P _{ARM} ⁽¹⁾	Repetitive peak avalanche	oower	28000	W	
V _{ARM} ⁽²⁾	Maximum repetitive peak avalanche voltage	$t_p < 1 \ \mu s, T_j < 1$	80	V	
V _{ASM} ⁽²⁾	Maximum repetitive peak avalanche voltage	$t_p < 1 \ \mu s, T_j < 1$	80	V	
T _{stg}	Storage temperature range		-65 to +175	°C	
T _j	Maximum operating junction	n temperature ⁽³⁾	150	°C	

For temperature or pulse time duration deratings, please refer to *Figure 4* and *5*. More details regarding the avalanche energy measurements and diode validation in the avalanche are provided in the application notes AN1768 and AN2025.

Table 3. Thermal parameters

Symbol	Parameter	Value	Unit
R _{th(j-c)}	Junction to case	1.0	°C/W

Static electrical characteristics Table 4.

Symbol	Parameter	Test conditions		Min.	Тур.	Max.	Unit
I _R ⁽¹⁾ Reverse leakage current	Reverse leakage	T _j = 25 °C	$V_R = V_{RRM}$	-	30	135	μΑ
	current	T _j = 125 °C		-	20	80	mA
V _F ⁽²⁾ F	Forward voltage drop	T _j = 25 °C	I _F = 15 A	-	0.500	0.540	٧
		T _j = 125 °C		-	0.410	0.470	
		T _j = 25 °C	1 20 4	-	0.570	0.640	V
		T _i = 125 °C	I _F = 30 A	-	0.515	0.600	

^{1.} Pulse test: t_p = 5 ms, δ < 2 %

To evaluate the conduction losses use the following equation: P = 0.435 x $I_{F(AV)}$ + 0.0055 x $I_{F}^{2}_{(RMS)}$

$$P = 0.435 \times I_{F(AV)} + 0.0055 \times I_{F(RMS)}^2$$

^{2.} See Figure 11

 $[\]frac{dPtot}{dTj} < \frac{1}{Rth(j-a)}$ condition to avoid thermal runaway for a diode on its own heatsink

^{2.} Pulse test: t_p = 380 μ s, δ < 2 %

STPS30SM60 Characteristics

Figure 2. Average forward power dissipation Figure 3. Average forward current versus versus average forward current ambient temperature ($\delta = 0.5$)

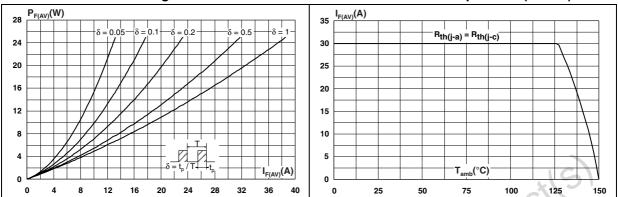


Figure 4. Normalized avalanche power derating versus pulse duration

Figure 5. Normalized avalanche power derating versus junction temperature

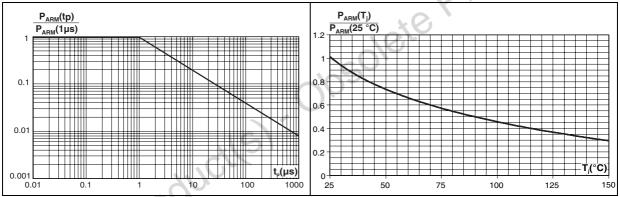
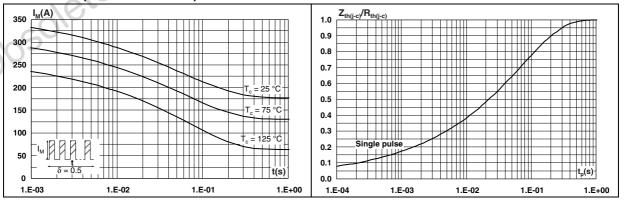


Figure 6. Non repetitive surge peak forward current versus overload duration (maximum values)

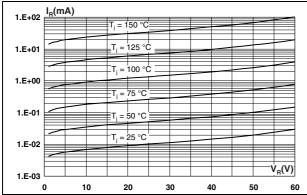
Figure 7. Relative thermal impedance junction to case versus pulse duration



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Figure 8. Reverse leakage current versus reverse voltage applied (typical values)

Figure 9. Junction capacitance versus reverse voltage applied (typical values)



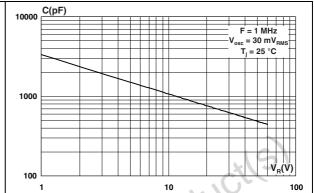
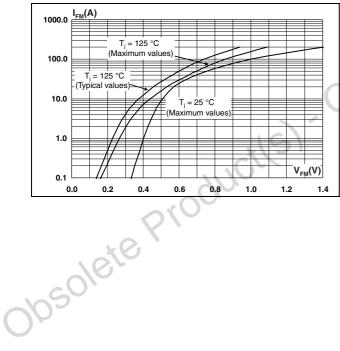
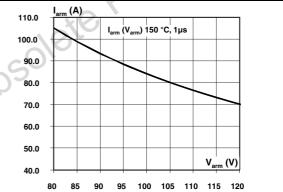


Figure 10. Forward voltage drop versus forward current

Figure 11. Reverse safe operating area $(t_p < 1 \mu s \text{ and } T_j < 150 \,^{\circ}\text{C})$





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2 Package information

- Epoxy meets UL94, V0
- Cooling method: by conduction (C)
- Recommended torque value: 0.4 to 0.6 N⋅m

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: www.st.com. ECOPACK[®] is an ST trademark.

Table 5. TO-220AC dimensions

			Dimensions			
		Ref.	Millim	eters	rs Inches	
			Min.	Max.	Min.	Max.
		Α	4.40	4.60	0.173	0.181
	H2 A ← A	C	1.23	1.32	0.048	0.051
	Ø I C .	D	2.40	2.72	0.094	0.107
	L5 L5	E	0.49	0.70	0.019	0.027
		F	0.61	0.88	0.024	0.034
	L6	F1	1.14	1.70	0.044	0.066
	L2	G	4.95	5.15	0.194	0.202
	F1 L9 D	H2	10.00	10.40	0.393	0.409
	<u>+ </u>	L2	16.40	typ.	0.64	5 typ.
	L4	L4	13.00	14.00	0.511	0.551
	→	L5	2.65	2.95	0.104	0.116
16	 E → E	L6	15.25	15.75	0.600	0.620
601	G	L7	6.20	6.60	0.244	0.259
Obsole		L9	3.50	3.93	0.137	0.154
0.		М	2.6	typ.	0.102	2 typ.
		Diam. I	3.75	3.85	0.147	0.151

STPS30SM60 Ordering information

Ordering information 3

Table 6. **Ordering information**

Order code	Marking	Package	Weight	Base qty	Delivery mode
STPS30SM60D	STPS30SM60D	TO-220AC	1.86 g	50	Tube

Revision history 4

Table 7. **Revision history**

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	Date	Revision		Changes
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